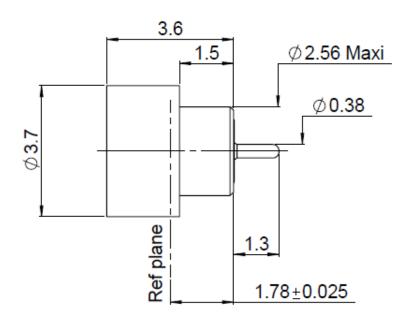


Technical Data Sheet

HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

PAGE 1/3 ISSUE 21-12-15B SERIES SMP PART NUMBER R222645000







All dimensions are in mm.



| COMPONENTS | MATERIALS | PLATING (μm) |
|----------------|-----------|------------------|
| Body | DILVER P1 | GOLD OVER NICKEL |
| Center contact | DILVER P1 | GOLD OVER NICKEL |
| Outer contact | | |
| Insulator | GLASS | |
| Gasket | | |
| Others parts | | |
| - | - | - |
| - | - | - |



Technical Data Sheet

HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

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|-----------------|------------------------|-------------------|-------------------------------|

PACKAGING

| Standard | Unit | Other |
|----------|------------|------------|
| 100 | Contact us | Contact us |

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} & \Omega \\ \text{Frequency} & & \textbf{0-40} & \text{GHz} \end{array}$

 VSWR
 1.15*
 +
 0.0000
 x F(GHz) Maxi

 Insertion loss
 0.12
 √F(GHz) dB Maxi

 RF leakage
 - (
 NA
 - F(GHz)) dB Maxi

 Voltage rating
 335
 Veff Maxi

 Dielectric withstanding voltage
 500
 Veff mini

 $\begin{array}{lll} \mbox{Dielectric withstanding voltage} & \mbox{\bf 500} & \mbox{Veff mini} \\ \mbox{Insulation resistance} & \mbox{\bf 500} & \mbox{M}\Omega \mbox{ mini} \\ \end{array}$

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating End
Axial force – Opposite end
Torque

6.8 N mini
6.8 N mini
N mini
N mini
N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini Weight 0.2200 g

ENVIRONMENTAL

Operating temperature -65/+165 °C
Hermetic seal 10-8 Atm.cm3/s
Panel leakage NA

SPECIFICATION

OTHER CHARACTERISTICS

Assembly instruction:NA

Others:

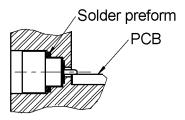
* to 18GHz





HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

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|-----------------|------------------------|-------------------|-------------------------------|



- 1. Degrease and clean connector and box
- Solder the connector on the panel we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C. Take care not to exceed 260°C during solder operation
- Solder the pin on the track
 we advise SnAg4 Cu0.5, we recommand a low residue flux.
 Preheating at 100 °C (only for ceramic substrate). Take care
 not to exceed 260°C during solder operation

